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STY50N105DK5

N-channel 1050 V, 0.110 Ω typ., 46 A MDmesh[™] DK5 Power MOSFET in a Max247 package

Datasheet - production data



Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	ID	Ртот
STY50N105DK5	1050 V	0.120 Ω	46 A	625 W

- Fast-recovery body diode
- Best R_{DS(on)} x area
- Low gate charge, input capacitance and resistance
- 100% avalanche tested
- Extremely high dv/dt ruggedness

Applications

• Switching applications

Description

This very high voltage N-channel Power MOSFET is part of the MDmeshTM DK5 fast recovery diode series. The MDmeshTM DK5 combines very low recovery charge (Q_{rr}) and recovery time (t_{rr}) with an excellent improvement in R_{DS(on)} * area and one of the most effective switching behaviors, ideal for half bridge and full bridge converters.

Table 1: Device summary

Order code	Marking	Packages	Packaging
STY50N105DK5	50N105DK5	Max247	Tube

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This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vgs	Gate-source voltage	±30	V
1-	Drain current (continuous) at $T_C = 25 \ ^{\circ}C$	46	А
lo	Drain current (continuous) at T _c = 100 °C	30	А
I _{DM} ⁽¹⁾	Drain current (pulsed)	184	А
Ρτοτ	Total dissipation at $T_C = 25 \text{ °C}$	625	W
dv/dt ⁽²⁾	Peak diode recovery voltage slope	50	V/ns
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	50	V/ns
Tj	Operating junction temperature range	55 to 150	°C
T _{stg}	Storage temperature range	-55 to 150 °	

Notes:

 $^{(1)}\mbox{Pulse}$ width limited by safe operating area

 $^{(2)}I_{SD} \leq 23$ A, di/dt ≤ 400 A/µs; V_{DS peak} $\leq V_{(BR)DSS},$ V_{DD} = 525 V $^{(3)}V_{DS} \leq 840$ V

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	0.2	°C/W
R _{thj-amb}	Thermal resistance junction-ambient		

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
las	Single pulse avalanche energy (pulse width limited by $T_{\mbox{\scriptsize JMAX}}$	16	А
E _{AS}	Single pulse avalanche energy (starting $T_J = 25^{\circ}C$, $I_D = I_{AS}$, $V_{DD} = 50 \text{ V}$)	1550	mJ



2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified)

Symbol	Parameter Test conditions		Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_D = 1 \text{ mA}, V_{GS} = 0 \text{ V}$	1050			V
	Zara gata valtaga drain	V_{DS} = 1050 V, V_{GS} = 0 V			1	μΑ
IDSS	IDSS Zero gate voltage drain current				50	μA
I _{GSS}	Gate-body leakage current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 100 \ \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on- resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 23 \text{ A}$		0.110	0.120	Ω

Table 5: On /off states

Notes:

 $^{(1)}\mbox{Defined}$ by design, not subject to production test

Symbol	Parameter	Test conditions		Тур.	Max.	Unit
Ciss	Input capacitance		-	6675	-	pF
Coss	Output capacitance	V _{DS} = 100 V, f = 1 MHz,	-	370	-	pF
Crss	Reverse transfer capacitance	V _{GS} = 0 V	-	10	-	pF
C _{o(tr)} ⁽¹⁾	Equivalent capacitance time related	V _{GS} = 0 V, V _{DS} = 0 to 840 V	-	630	-	pF
C _{o(er)} ⁽²⁾	Equivalent capacitance energy related	$V_{\rm GS} = 0 V, V_{\rm DS} = 0 10 840 V$	-	219	-	
R_{G}	Intrinsic gate resistance	f = 1 MHz open drain	-	3	-	Ω
Qg	Total gate charge	$V_{DD} = 840 V, I_D = 46 A,$	-	204	-	nC
Qgs	Gate-source charge	Vgs = 10 V	-	36	-	nC
Q _{gd}	Gate-drain charge	(see Figure 15: "Test circuit for gate charge behavior")	-	133	-	nC

Table 6: Dynamic

Notes:

 $^{(1)}$ Time related is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS} .

 $^{(2)}\mathsf{E}\mathsf{nergy}$ related is defined as a constant equivalent capacitance giving the same stored energy as C_{OSS} when V_{DS} increases from 0 to 80% V_{DSS} .



Electrical characteristics

Table 7: Switching times							
Symbol	Parameter	Min.	Тур.	Max.	Unit		
t _{d(on)}	Turn-on delay time	V _{DD} = 525 V, I _D = 23 A,	-	40.6	-	ns	
tr	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$	-	64.5	-	ns	
t _{d(off)}	Turn-off delay time	(see Figure 14: "Test circuit for resistive load switching times"	-	262	-	ns	
t _f	Fall time	and Figure 19: "Switching time waveform")	-	49.5	-	ns	

Table 8: Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Isd	Source-drain current		-		46	А
Isdm	Source-drain current (pulsed)		-		184	А
V _{SD} ⁽¹⁾	Forward on voltage	I _{SD} = 46 A, V _{GS} = 0 V	-		1.5	V
trr	Reverse recovery time	I _{SD} = 46 A, V _{DD} = 60 V,	-	273		ns
Qrr	Reverse recovery charge	di/dt = 100 A/µs (see <i>Figure 16: "Test circuit for</i>	-	3		μC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times")	-	23		А
trr	Reverse recovery time	I _{SD} = 46 A, V _{DD} = 60 V,	-	477		ns
Qrr	Reverse recovery charge	di/dt = 100 A/ μ s, T _j = 150 °C (see <i>Figure 16: "Test circuit for</i>	-	10		μC
Irrm	Reverse recovery current	inductive load switching and diode recovery times")	-	42		A

Notes:

 $^{(1)}\text{Pulsed:}$ pulse duration = 300 µs, duty cycle 1.5%









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Electrical characteristics







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3 Test circuits







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4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

4.1 Max247 package information



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Package information

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T.I.I. 0.14. 0/7			1.4.
Table 9: Max247	package	mecnanical	data

Dim.	mm				
Dim.	Min.	Тур.	Max.		
A	4.70	-	5.30		
A1	2.20	-	2.60		
b	1.00	-	1.40		
b1	2.00	-	2.40		
b2	3.00	-	3.40		
С	0.40	-	0.80		
D	19.70	-	20.30		
е	5.35	-	5.55		
E	15.30	-	15.90		
L	14.20	-	15.20		
L1	3.70	-	4.30		



5 Revision history

Date	Revision	Changes
24-Jan-2013	1	First release
19-Dec-2016	2	Datasheet status promoted from preliminary to production data. Updated features, description and internal schematic diagram on cover page. Updated Section 1: "Electrical ratings" and Section 2: "Electrical characteristics". Minor text changes



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